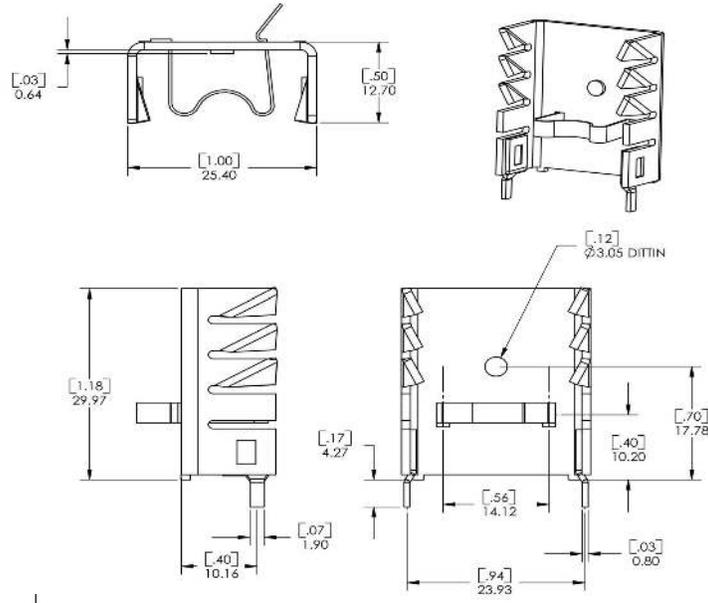
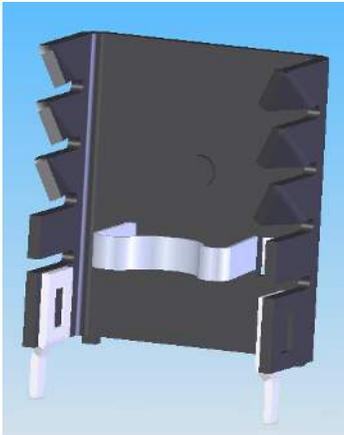


# Board Level Heat Sinks



**P/N: 825502B03453**



## PRODUCT SPECIFICATIONS

- Devices: TO-220
- Size: 25.4 x 12.7 x 30.0 mm
- Material: Aluminum, 1.2 mm
- Type: Stamped
- IC Mounting: Integrated Spring
- PCB Mounting: Solderable Tabs
- Finish: Black Anodized
- Package: Bulk
- Optional Hardware: Thermal Interface Material

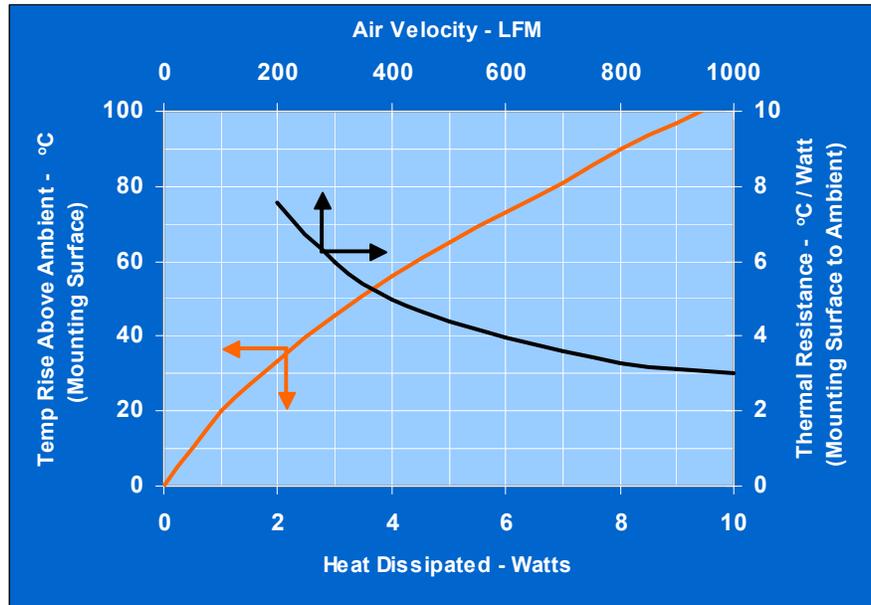
## FEATURES & BENEFITS

- Includes Spring Clip for Quick Device Attachment
- Curled Flow Fins
- Vertical Mounting via Solderable Tabs
- RoHS Compliant



## CUSTOMIZED HEATSINKS

- Specialized Tabs, Plating
- Specialized Body Configurations
- Contact Applications Engineering



**TO-220**

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